

**GigaDevice Semiconductor Inc.**

**GD32VW553 Quick Development Guide**

**Application Note**

**AN154**

Revision 1.3a

(May 2025)

# Table of Contents

<b>Table of Contents.....</b>	<b>2</b>
<b>List of Figures .....</b>	<b>4</b>
<b>List of Tables .....</b>	<b>6</b>
<b>1. Introduction to development board .....</b>	<b>7</b>
1.1. Picture of real development board .....	7
1.1.1. The START development board .....	7
1.1.2. The EVAL development board .....	7
1.2. Boot mode .....	9
1.3. Debugger interface.....	9
1.4. Download interface .....	10
1.5. Viewing log.....	10
<b>2. Building development environment.....</b>	<b>11</b>
2.1. Installation of GD32 Embedded Builder .....	11
2.2. Installation of SEGGER Embedded Studio IDE .....	11
<b>3. What developers must know.....</b>	<b>12</b>
3.1. SDK execution program group .....	12
3.2. SDK configuration.....	12
3.2.1. Configuration of wireless module .....	12
3.2.2. SRAM layout .....	13
3.2.3. FLASH layout .....	13
3.2.4. Firmware version No.....	13
3.2.5. APP configuration .....	14
3.2.6. Configuration Selection .....	15
3.3. Correct log example.....	16
<b>4. GD32 Embedded Builder IDE project.....</b>	<b>17</b>
4.1. Opening the project group.....	17
4.2. Compilation .....	20
4.3. Download firmware .....	23
4.3.1. USB Drive Copy.....	23
4.3.2. Use afterbuild.bat for downloading .....	23
4.3.3. Using J-Flash Lite for downloading .....	24
4.4. Debugging.....	25

<b>5.</b>	<b>SEGGER Embedded Studio IDE project.....</b>	<b>28</b>
5.1.	Open projects.....	28
5.2.	Compilation .....	29
5.3.	Download firmware .....	31
5.4.	Debugging.....	32
<b>6.</b>	<b>FAQ.....</b>	<b>34</b>
6.1.	No image error .....	34
6.2.	Code running in SRAM .....	34
6.3.	How to select different project configurations during debugging.....	34
<b>7.</b>	<b>Revision history .....</b>	<b>37</b>

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## List of Figures

Figure 1-1. The picture of the START development board .....	7
Figure 1-2. The picture of the EVAL development board.....	8
Figure 1-3. Development Board Type Configuration.....	9
Figure 1-4. List of devices and drivers .....	10
Figure 1-5. Configuration of serial port.....	10
Figure 2-1 The Directory Structure of GD32 Embedded Builder .....	11
Figure 3-1. Boot process .....	12
Figure 3-2. Configuration of wireless module .....	12
Figure 3-3. SRAM layout.....	13
Figure 3-4. FLASH layout.....	13
Figure 3-5. Firmware version No.....	14
Figure 3-6 BLE library selection .....	14
Figure 3-7. Project boot information .....	16
Figure 4-1. SDK directory.....	17
Figure 4-2. Starting GD32 Embedded Builder IDE.....	17
Figure 4-3. Open Projects from file System .....	18
Figure 4-4. Selecting MBL project path .....	18
Figure 4-5. MBL project interface.....	19
Figure 4-6. Selecting MSDK project path.....	19
Figure 4-7. MSDK and MBL project interfaces .....	20
Figure 4-8. Properties of the project .....	20
Figure 4-9. Compiling the MBL project.....	21
Figure 4-10. MBL compilation result .....	21
Figure 4-11. target configuration selection.....	22
Figure 4-12. MSDK compilation result.....	22

Figure 4-13. Images output .....	23
Figure 4-14 Configure image automatic downloading .....	23
Figure 4-15 JFlashLite Configuration.....	24
Figure 4-16 J-Flash Programming Interface.....	24
Figure 4-17. Opening the Debug Configuration option .....	25
Figure 4-18. MSDK debug configuration .....	26
Figure 4-19. MSDK Debugging Configuration Interface with openocd .....	26
Figure 4-20. MSDK debug interface .....	27
Figure 5-1. MBL SES Project Project Interface .....	28
Figure 5-2. MSDK SES Project Interface .....	29
Figure 5-3. nuclei toolchain content.....	29
Figure 5-4. Compiling the MBL project.....	30
Figure 5-5. MBL compilation result.....	30
Figure 5-6. Compile MSDK project.....	30
Figure 5-7 MSDK Project Configuration Options.....	31
Figure 5-8 MSDK compilation result .....	31
Figure 5-9. Images output.....	31
Figure 5-10 SES IDE image download.....	32
Figure 5-11. MSDK SES Project Configuration Interface .....	33
Figure 5-12. SES IDE Debug Interface .....	33
Figure 6-1 Select Project Configuration for Debugging .....	35

## List of Tables

Table 1-1. Boot mode.....	9
Table 7-1. Revision history.....	37

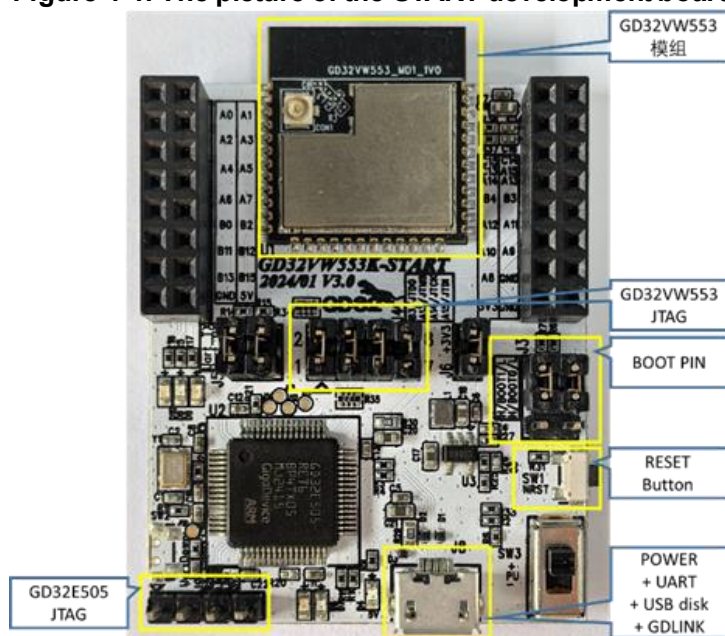
## 1. Introduction to development board

### 1.1. Picture of real development board

#### 1.1.1. The START development board

The START development board consists of a baseboard and a module equipped with the GD32VW55x Wi-Fi+BLE chip.

**Figure 1-1. The picture of the START development board**



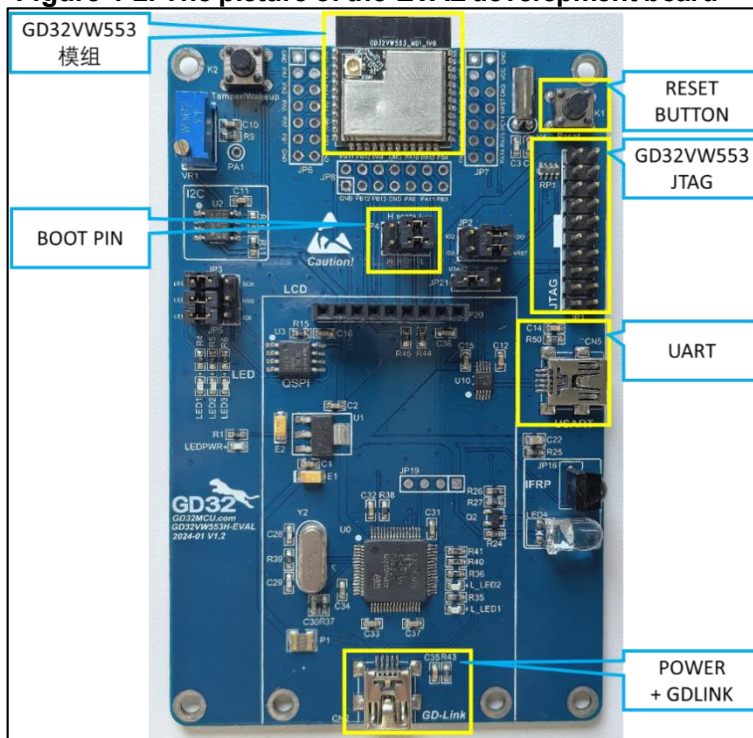
Mainly focus on the following parts of the development board, which have been marked in the [Figure 1-1. The picture of the START development board](#).

- Boot mode (Boot PIN);
- Power supply port (POWER);
- View log (UART);
- Debugger interface (JLink, or GDLink);
- Reboot (Reset Button).

#### 1.1.2. The EVAL development board

The EVAL development board consists of a baseboard and a module equipped with the GD32VW55x Wi-Fi+BLE chip. The baseboard lead out many peripheral test ports, such as I2C, IFRP, ADC and so on.

**Figure 1-2. The picture of the EVAL development board**



Developers mainly focus on the following parts of the development board, which have been marked in the [Figure 1-2. The picture of the EVAL development board](#).

- Boot mode (Boot PIN);
- Power supply port (power supply);
- View log (UART);
- Debugger interface (JLink, or GDLink);
- Reboot (Reset Button).

For the START development board and the EVAL development board, the SDK configuration is different and different macros need to be selected to enable them. As shown in [Figure 1-3. Development Board Type Configuration](#), the SDK selects the START development board configuration as the default. The configuration file is GD32VW55x\_RELEASE/config/platform\_def.h.



**Figure 1-3. Development Board Type Configuration**

```
// board type
#define PLATFORM_BOARD_32VW55X_START 0
#define PLATFORM_BOARD_32VW55X_EVAL 1
#define PLATFORM_BOARD_32VW55X_F527 2
#ifdef CONFIG_PLATFORM_ASIC
#define CONFIG_BOARD PLATFORM_BOARD_32VW55X_START
#endif
```

## 1.2. Boot mode

GD32VW55x can boot from ROM, FLASH, or SRAM.

The level selection of the two pins BOOT0 and BOOT1 in the BOOT SWD box of the development board determines the boot mode. See [Table 1-1. Boot mode](#). For more instructions on the boot mode, please refer to the document "GD32VW55x\_User\_Manual".

**Table 1-1. Boot mode**

EFBOOTLK	BOOT0	BOOT1	EFSB	Boot address	Boot area
0	0	-	0	0x08000000	SIP Flash
0	0	-	1	0x0BF46000	secure boot
0	1	0	-	0x0BF40000	Bootloader/ROM
0	1	1	-	0x20000000	SRAM
1	0	-	0	0x08000000	SIP Flash
1	0	-	1	0x0BF46000	Secure boot
1	1	-	-	0x0BF40000	Bootloader/ROM

## 1.3. Debugger interface

For START development board, it comes with a GDLink(GD32E505) debugger that can be used with OpenOCD. Can also use an external debugger (GDLink or JLink) at the JTAG interface of the board for debugging and download. The GD32E505 chip also integrates the UART function, so only one USB cable is required to supply power, debug, and view the log. Connect the pins JCLK, JTWS, JTDO and JTDI to the middle four pins through jumper caps, and then download and debug the code through DAPLINK. [Figure 1-1. The picture of the START development board](#) shows how to debug through DAPLINK.

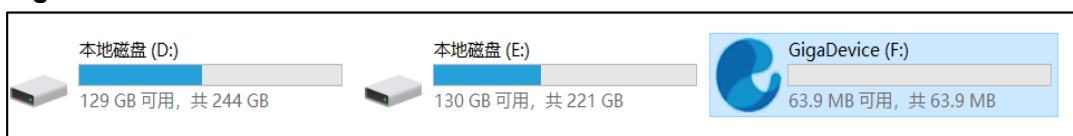
For EVAL development board, GDLink or JLink debugger can be used for debugging and download.

It should also be noted that the GD32VW55x supports cJTAG and JTAG but does not support the SWD debugging interface.

## 1.4. Download interface

For the START development board, in addition to using the GDLink debugger or JLink debugger mentioned in the previous section for firmware downloading, if debugging functionality is not required and only firmware downloading is needed, the firmware can also be downloaded using a USB drive copy method. Connect the development board to a computer via a USB cable, as shown in [Figure 1-4. List of devices and drivers](#), under the devices and drives list as the GigaDevice drive. Copy the "image-all.bin" file (refer to subsequent sections) into the GigaDevice drive to complete the FLASH programming of the GD32VW55x chip.

**Figure 1-4. List of devices and drivers**

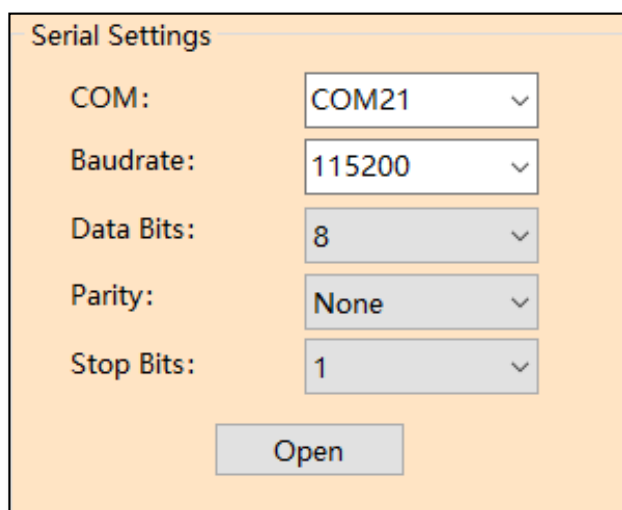


For EVAL development board, GDLink or JLink debugger can be used for download. Dragging into the USB disk is not supported.

## 1.5. Viewing log

Connect a MicroUSB cable to the START development board, use a serial port tool on the PC, and configure it according to the parameters in [Figure 1-5. Configuration of serial port](#) and connect to the board. After that, use the serial port to output logs.

**Figure 1-5. Configuration of serial port**



## 2. Building development environment

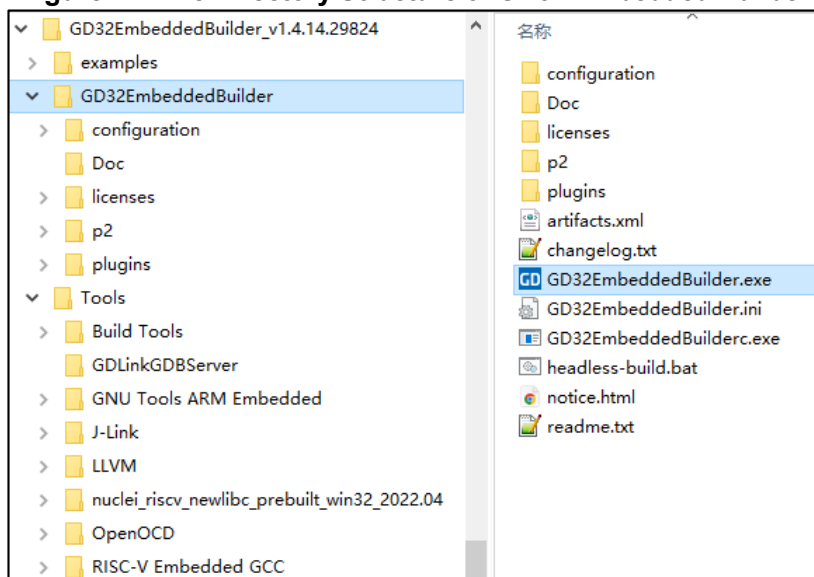
Build a development environment before compiling and downloading the firmware.

The development tool currently used is GD32 Embedded Builder and SEGGER Embedded Studio IDE.

### 2.1. Installation of GD32 Embedded Builder

The GD32 Embedded Builder can select GD32VW5 at website: <https://gd32mcu.com/cn/download> to download. The uncompressed downloaded files is as [Figure 2-1 The Directory Structure of GD32 Embedded Builder](#) shows. The build tool, tool chain, openocd, jlink, and other related tools have all been placed in the Tools directory.

**Figure 2-1 The Directory Structure of GD32 Embedded Builder**



### 2.2. Installation of SEGGER Embedded Studio IDE

Please visit the website: <https://wiki.segger.com/GD32V> for how to get the SEGGER Embedded Studio IDE and License Activation Key.

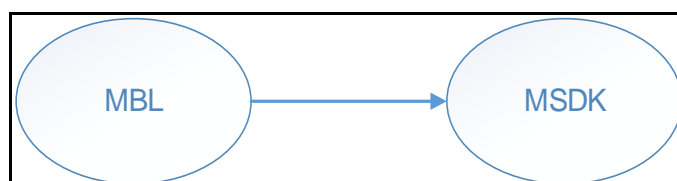
### 3. What developers must know

Before getting started with development, first understand the members of the SDK execution program group, how to correctly configure the SDK.

#### 3.1. SDK execution program group

SDK will finally generate two main execution programs: MBL (Main Bootloader) and MSDK (Main SDK), which will eventually be downloaded to FLASH to run. After power-on, the programs will boot from Reset\_Handler of MBL, and then jump to the MSDK main program to run, as shown in [Figure 3-1. Boot process](#).

**Figure 3-1. Boot process**



#### 3.2. SDK configuration

##### 3.2.1. Configuration of wireless module

The configuration file is GD32VW55x\_RELEASE/config/platform\_def.h, whose main content is as shown in [Figure 3-2. Configuration of wireless module](#).

**Figure 3-2. Configuration of wireless module**

```

#define CFG_WLAN_SUPPORT
#define CFG_BLE_SUPPORT
#if defined(CFG_WLAN_SUPPORT) && defined(CFG_BLE_SUPPORT)
    #define CFG_COEX
#endif
  
```

- In the case of BLE/ WiFi combo mode, please enable:
  - #define CFG\_WLAN\_SUPPORT
  - #define CFG\_BLE\_SUPPORT
- In the case of BLE only, please only enable:
  - #define CFG\_BLE\_SUPPORT
- In the case of WiFi only, please only enable:
  - #define CFG\_WLAN\_SUPPORT
- To disable the wireless module, please disable all

### 3.2.2. SRAM layout

The configuration file is GD32VW55x\_RELEASE\config\config\_gdm32.h. Modify the following macro definition (as [Figure 3-3. SRAM layout](#) shows) values to plan the SRAM space occupied by the executable program segments MBL and IMG. These values are offset addresses, and the base address is defined at the beginning of the file.

The line marked "!!Keep unchanged!!" cannot be modified; otherwise, the operation of the MbedTLS code in the ROM will be affected.

**Figure 3-3. SRAM layout**

```
/* SRAM LAYOUT */
#define RE_MBL_DATA_START ..... 0x300 ..... /* !!Keep unchanged! */
#define RE_IMG_DATA_START ..... 0x200 ..... /* !!Keep unchanged! */
```

For the planning of SRAM space in each executable program segment, refer to the .ld file under the corresponding project, such as MBL\project\eclipse\mbl.ld and MSDK\p\frisc\env\gd32w55x.ld.

### 3.2.3. FLASH layout

The configuration file is GD32VW55x\_RELEASE\config\config\_gdm32.h. Modify the following macro definition (as [Figure 3-4. FLASH layout](#) shows) values to plan the FLASH space occupied by the executable program segments MBL and MSDK. These values are offset addresses, and the base address is defined at the beginning of the file.

The line marked "!!Keep unchanged!!" cannot be modified; otherwise, the operation of the project will be affected.

**Figure 3-4. FLASH layout**

```
/* FLASH LAYOUT */
#define RE_VTOR_ALIGNMENT ..... 0x200 ..... /* !!Keep unchanged! */
#define RE_SYS_SET_OFFSET ..... 0x0 ..... /* !!Keep unchanged! */
#define RE_MBL_OFFSET ..... 0x0 ..... /* 0x0: Boot from MBL, 0x1000: Boot from ROM */
#define RE_SYS_STATUS_OFFSET ..... 0x8000 ..... /* !!Keep unchanged! */
#define RE_IMG_0_OFFSET ..... 0xA000 ..... /* !!Keep unchanged! */
#define RE_IMG_1_OFFSET ..... 0x1E000
#define RE_IMG_1_END ..... 0x3CB000 ..... /* reserved 192KB for user data */
#define RE_NVDS_DATA_OFFSET ..... 0x3FB000 ..... /* reserved 20KB for nvds data */
#define RE_END_OFFSET ..... 0x400000 ..... /* equal to flash total size */
```

For the planning of FLASH space in each executable program segment, refer to the .ld file under the corresponding project, such as MBL\project\eclipse\mbl.ld and MSDK\p\frisc\env\gd32w55x.ld.

### 3.2.4. Firmware version No.

The configuration file is GD32VW55x\_RELEASE\config\config\_gdm32.h. Modify the following

macro definition values showed in [Figure 3-5. Firmware version No.](#) to specify the version No. In addition, the macro RE\_IMG\_VERSION is used in Securt Boot to determine the firmware version.

MBL only supports local upgrade, while IMG supports online upgrade. The version No. released by the SDK is consistent with RE\_IMG\_VERSION.

**Figure 3-5. Firmware version No.**

```
/* FW_VERSION */
#define RE_MBL_VERSION .....0x01000003
#define RE_IMG_VERSION .....0x01000003
```

### 3.2.5. APP configuration

The configuration file is GD32VW55x\_RELEASE\MSDK\app\app\_cfg.h. Choose whether to enable some applications, such as ATCMD, Alibaba Cloud, MQTT, COAP and so on.

By modifying the macro CONFIG\_BLE\_LIB in app\_cfg.h, the BLE library can be switched. When CONFIG\_BLE\_LIB is set to BLE\_LIB\_MIN (as shown in [Figure 3-6 BLE library selection](#)), the project compilation will use libble.a, and the header file will include ble\_config\_min.h. When CONFIG\_BLE\_LIB is set to BLE\_LIB\_MAX, the project compilation will use libble\_max.a, and the header file will include ble\_config\_max.h.

**Figure 3-6 BLE library selection**

```
#define BLE_LIB_MIN .....0 .....//only peripheral and server
#define BLE_LIB_MAX .....1 .....//add central and client usage

#define CONFIG_BLE_LIB .....BLE_LIB_MIN
```

The features supported by libble.a are as follows:

1. Supports peripheral
2. Supports a single connection link
3. Supports server
4. Supports host and controller
5. Supports EATT
6. Supports WeChat applet WiFi provisioning

Based on libble.a, libble\_max.a additionally supports the following features:

1. Supports central
2. Supports four connection links
3. Supports client

4. Supports periodic advertising
5. Supports PHY updates
6. Supports power control
7. Supports BLE ping
8. Supports secure connection

### 3.2.6. Configuration Selection

The main project-MSDK, supports multiple configurations, with `msdk` selected by default. Additional options include `msdk_ffd`, `msdk_mbedtls_2.17.0`, `msdk_rttthread`, and `msdk_threadx`.

The main difference between `msdk_ffd` and `msdk` lies in the WiFi connection management library included in the project. The `msdk` includes `libwpas`, which is more streamlined and consumes fewer memory resources. The `msdk_ffd` includes `wpa_supplicant`, which is more comprehensive and general-purpose but has a larger codebase and consumes more memory resources. Additionally, `msdk_ffd` includes `libble_max.a` by default, enabling more BLE features. Of course, `msdk` can switch between `libble.a` and `libble_max.a` by modifying the configuration.

The main difference between `msdk_mbedtls_2.17.0` and `msdk` lies in the version of the MbedTLS library included in the project. The `msdk` includes MbedTLS 3.6.2, which runs in FLASH. The `msdk_mbedtls_2.17.0` includes MbedTLS 2.17.0, with most of its content running in ROM. If strict security requirements are needed, it is recommended to choose `msdk`. If FLASH space is limited, it is recommended to choose `msdk_mbedtls_2.17.0`.

The main difference between `msdk_rttthread` and `msdk` lies in the RTOS used in the project. The `msdk` uses FreeRTOS. The `msdk_rttthread` uses RT-Thread.

The main difference between `msdk_threadx` and `msdk` also lies in the RTOS used in the project. The `msdk` uses FreeRTOS. The `msdk_threadx` uses ThreadX.

- `msdk`  
FreeRTOS + `Libwpas.a` + `libble.a` + MbedTLS 3.6.2
- `msdk_ffd`  
FreeRTOS + `wpa_supplicant.a` + `libble_max.a` + MbedTLS 3.6.2
- `msdk_mbedtls_2.17.0`  
FreeRTOS + `Libwpas.a` + `libble.a` + ROM MbedTLS 2.17.0
- `msdk_rttthread`  
RTThread + `Libwpas.a` + `libble.a` + MbedTLS 3.6.2

- msdk\_threadx

Threadx + Libwpas.a + libble.a + MbedTLS 3.6.2

For details on how to make configuration selection for actual use, see the Compiling MSDK Projects section in subsection [4.2Compilation](#).

### 3.3. Correct log example

After the firmware group (MBL+MSDK) is successfully downloaded, open the serial port tool, and press the Reset button on the development board. The startup information is shown in [Figure 3-7. Project boot information](#). If an exception occurs, please check [6FAQ](#) for help.

**Figure 3-7. Project boot information**

```
ALW: MBL: First print.
ALW: MBL: Boot from Image 0.
ALW: MBL: Validate Image 0 OK.
ALW: MBL: Jump to Main Image (0x0800a000).
=== RF initialization finished ===
SDK Version: v1.0.3a-86d78d058d779fad
Build date: 2025/05/14 16:29:11
=== WiFi calibration done ===
=== PHY initialization finished ===
BLE local addr: AB:89:67:45:23:01, type 0x0
=== BLE Adapter enable complete ===
```



## 4. GD32 Embedded Builder IDE project

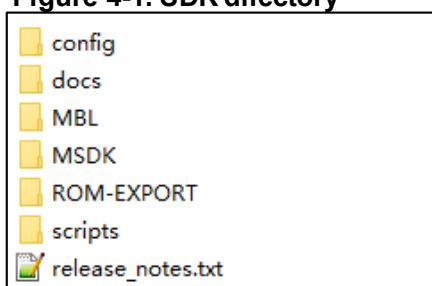
This chapter introduces how to compile and debug the SDK under Embedded Builder IDE.

The project group consists of two projects: MBL/MSDK. MSDK includes Wi-Fi protocol stack, BLE protocol stack, peripheral drivers, applications, etc. The MBL is mainly responsible for selecting the correct MSDK firmware from the two (current firmware and OTA firmware) to run.

### 4.1. Opening the project group

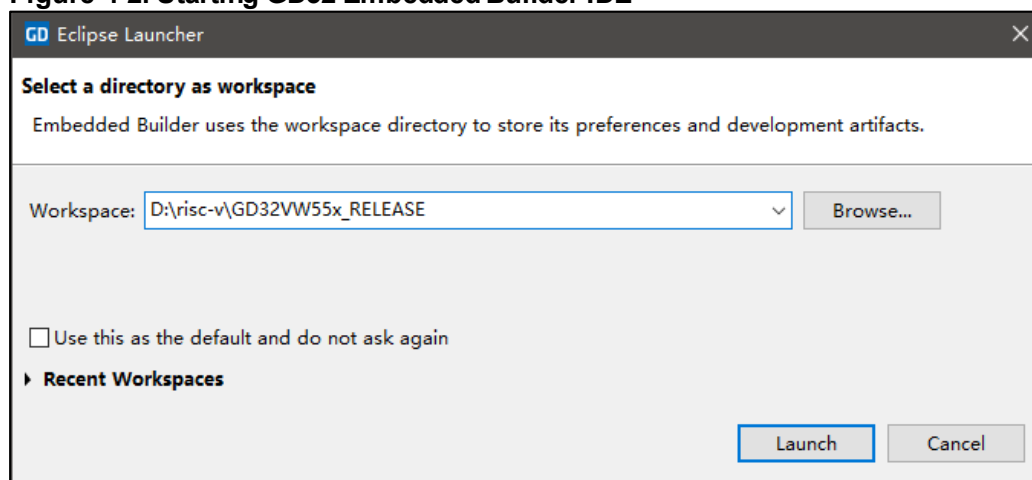
Check the SDK directory GD32VW55x\_RELEASE, as shown in [Figure 4-1. SDK directory](#).

**Figure 4-1. SDK directory**



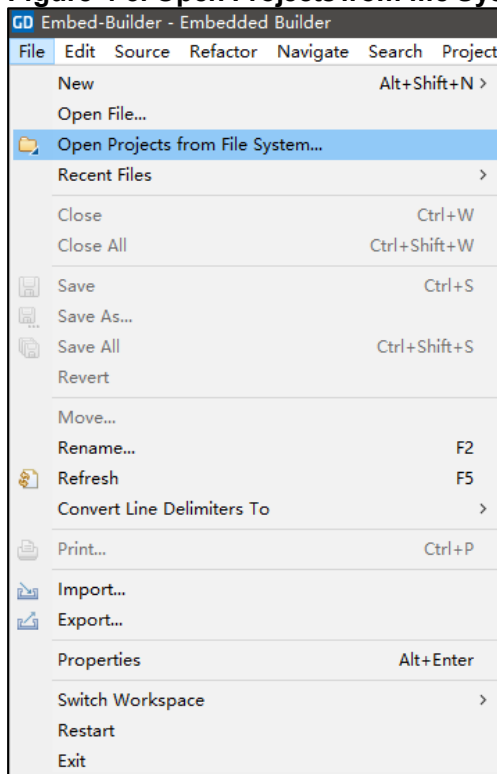
To start the IDE, double-click Embedded Builder.exe in the Embedded Builder directory, and select the SDK directory GD32VW55x\_RELEASE as the workspace, and then click the launch button, as shown in [Figure 4-2. Starting GD32 Embedded Builder IDE](#).

**Figure 4-2. Starting GD32 Embedded Builder IDE**

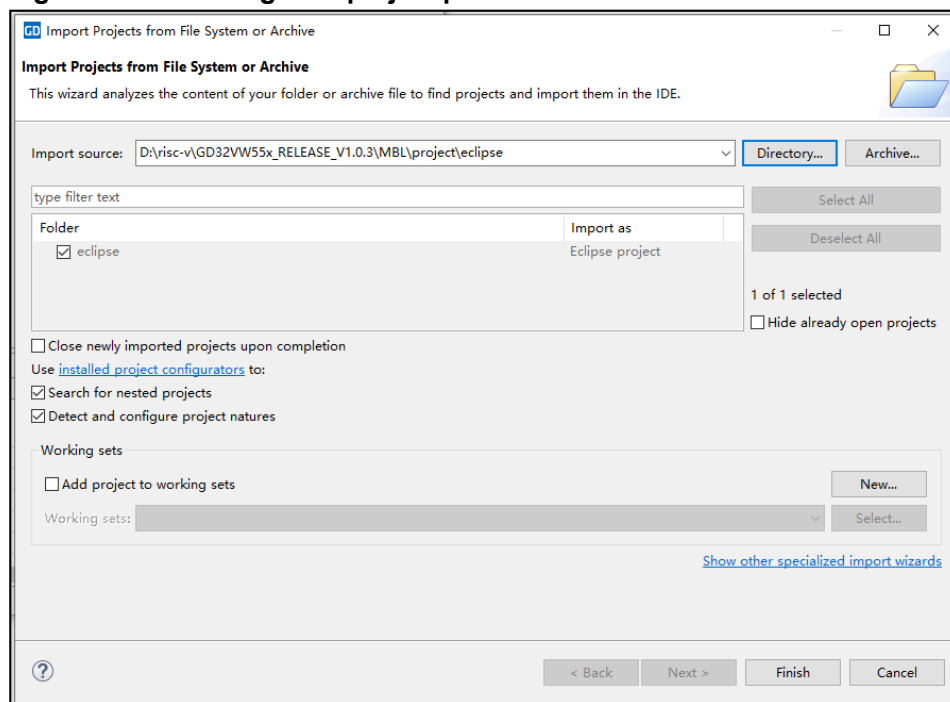


- Import the MBL project

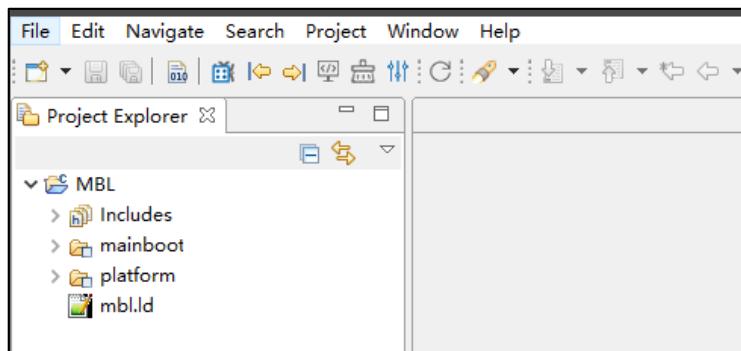
In the File menu, click Open Projects from file System, as shown in [Figure 4-3. Open Projects from file System](#).

**Figure 4-3. Open Projects from file System**


Select the project path `GD32VW55x_RELEASE\MBL\project\eclipse`, as shown in [Figure 4-4. Selecting MBL project path](#), and click Finish.

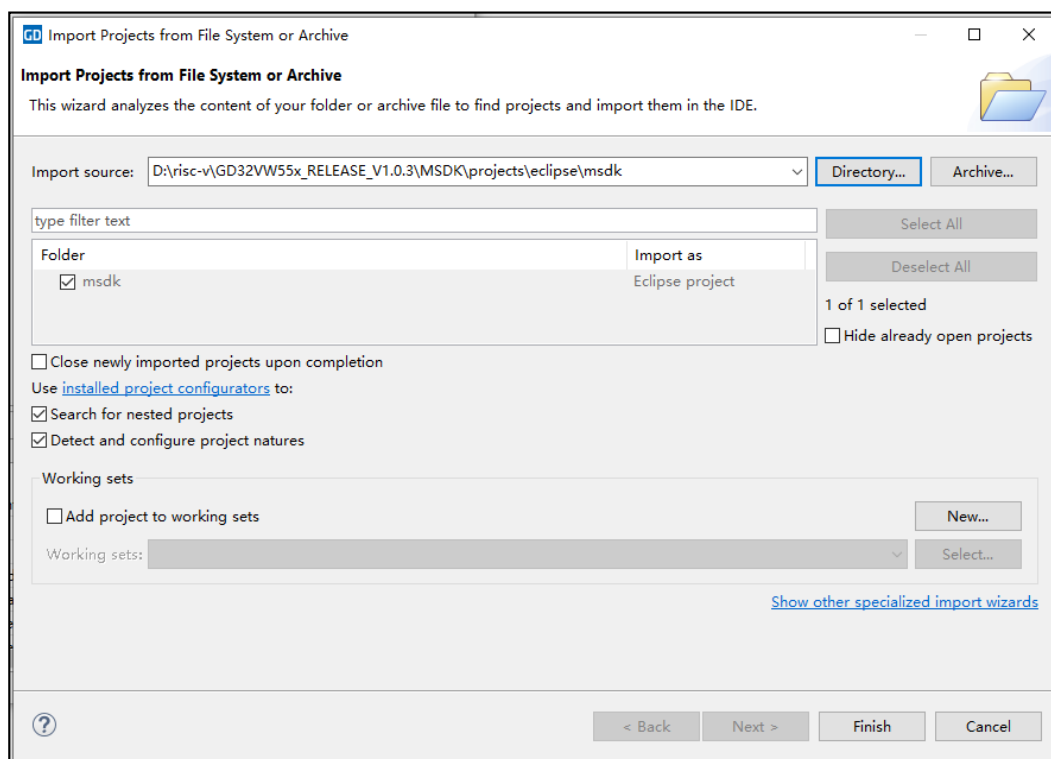
**Figure 4-4. Selecting MBL project path**


Close the welcome interface, and the MBL project is shown as [Figure 4-5. MBL project interface](#) shows.

**Figure 4-5. MBL project interface**


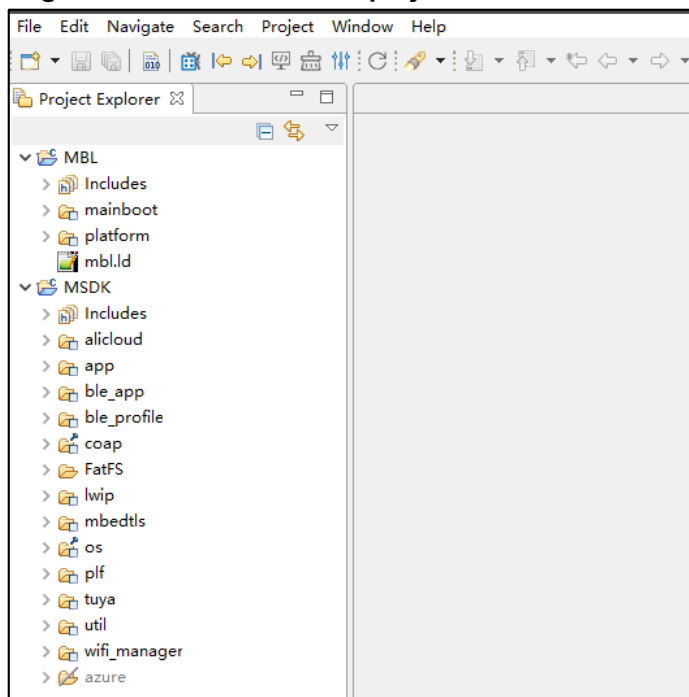
#### ■ Import the MSDK project

In the File menu, click Open Projects from file System, Select the project path GD32VW55x\_RELEASE\MSDK\projects\eclipse\msdk, as shown in [Figure 4-6. Selecting MSDK project path](#), and click Finish.

**Figure 4-6. Selecting MSDK project path**


View the MSDK and MBL project interfaces, as shown in [Figure 4-7. MSDK and MBL project interfaces](#).

**Figure 4-7. MSDK and MBL project interfaces**

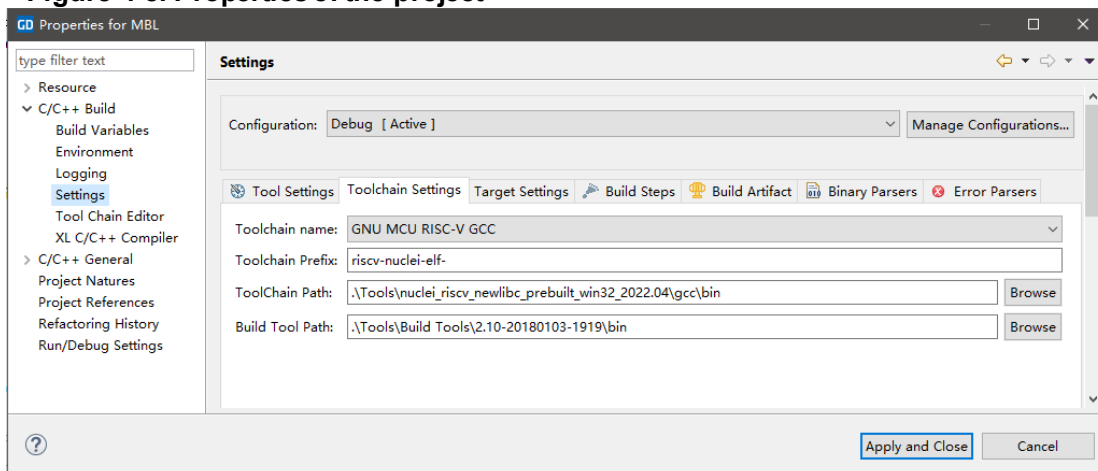


## 4.2. Compilation

- Check the configuration of the project compilation tool

Right-click on the project, click on properties, select C/C++ Build -> Settings in order, and on the tab click on toolchain settings., as shown in [Figure 4-8. Properties of the project](#).

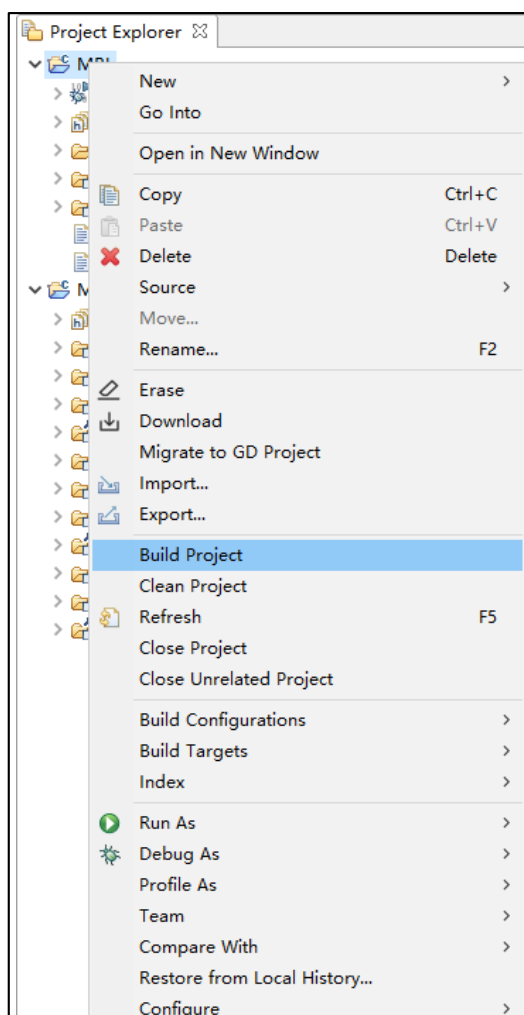
**Figure 4-8. Properties of the project**



- Compile the MBL project

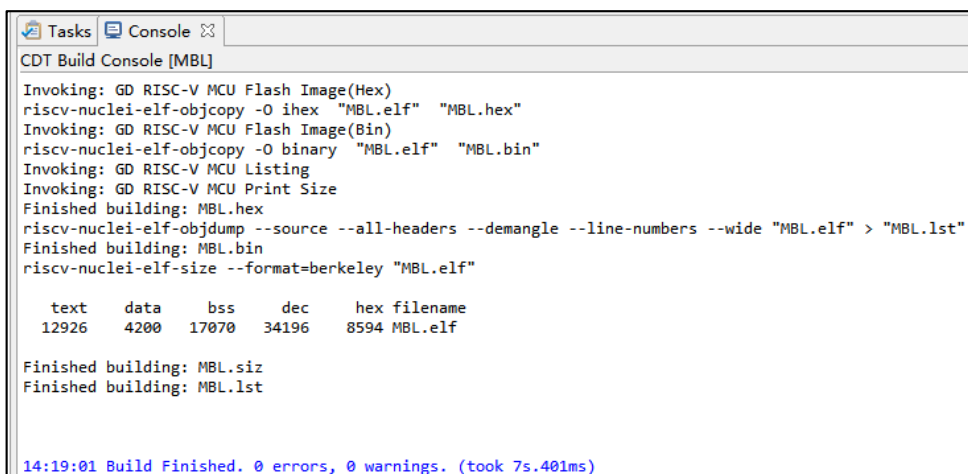
Right-click the project, and click Build Project, as shown in [Figure 4-9. Compiling the MBL project](#).

**Figure 4-9. Compiling the MBL project**



The compilation result is as shown in [Figure 4-10. MBL compilation result](#).

**Figure 4-10. MBL compilation result**

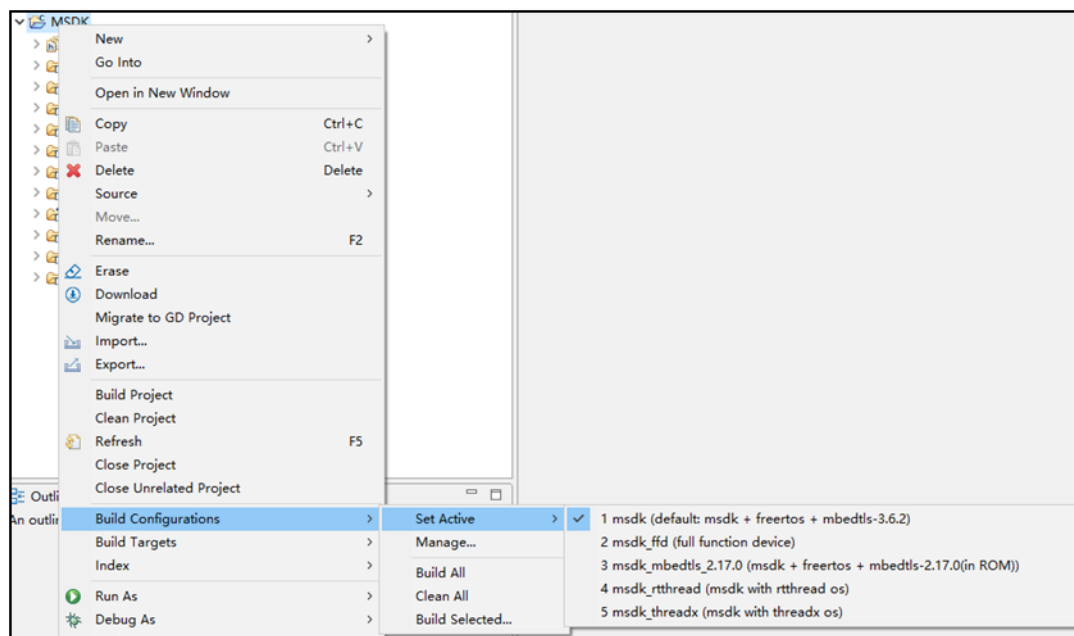


After the compilation is complete, the script `MBL\project\mbl_afterbuild.bat` will be automatically called to generate `mbl.bin` and copied to the directory `\scripts\images`.

### ■ Compile the MSDK project

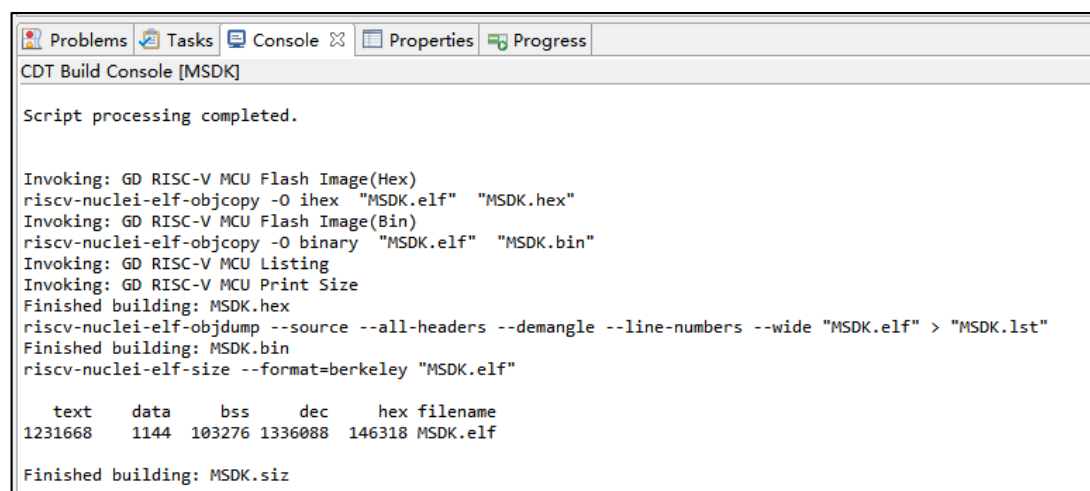
Right-click the project, and click Build Configurations—>Set Active—><target configuration> in order. as shown in [Figure 4-11. target configuration selection](#), the default target project is msdk.

**Figure 4-11. target configuration selection**



Right-click the project again, and click Build Project, The compilation result is as shown in [Figure 4-12. MSDK compilation result](#).

**Figure 4-12. MSDK compilation result**



### ■ Images generated by SDK

After MSDK is compiled, it will call MSDK\projects\image\_afterbuild.bat to generate image-ota.bin and image-all.bin, and copy the generated bin files to \scripts\images, as shown in [Figure 4-13. Images output](#).

image-ota.bin is the bin file generated by MSDK project, which can be used for OTA upgrade. image-all.bin is the combination of MBL(mbl.bin) and MSDK(image-ota.bin), the firmware can be used for production, download into FLASH and run.

**Figure 4-13. Images output**

名称	修改日期	类型	大小
 image-all.bin	2024/7/11 14:26	BIN 文件	788 KB
 image-ota.bin	2024/7/11 14:26	BIN 文件	748 KB
 mbl.bin	2024/7/11 14:19	BIN 文件	17 KB

## 4.3. Download firmware

### 4.3.1. USB Drive Copy

As shown in [1.4Download interface](#), copying the image-all.bin file from GD32VW55x\_RELEASE\scripts\images to the GigaDevice drive. This functionality is only supported on the START development board when using the onboard GDLink connection.

### 4.3.2. Use afterbuild.bat for downloading

The project supports automatically downloading the image after compilation by invoking a script through afterbuild. The script file is MSDK\projects\image\_afterbuild.bat.

At the end of image\_afterbuild.bat, there is a section of code configured for automatic image downloading, as shown in [Figure 4-14 Configure image automatic downloading](#).

**Figure 4-14 Configure image automatic downloading**

```
:download
set OPENOCD="%OPENOCD_PATH%\openocd.exe"
::set LINKCFG="..\openocd_gdlink.cfg"
set LINKCFG="..\openocd_jlink.cfg"
@echo on
::%OPENOCD% -f %LINKCFG% -c "program %DOWNLOAD_BIN% 0x0800A000 verify reset exit;"
:end
```

This segment of code utilizes OpenOCD with Jlink/GDLink to perform downloading. By configuring OpenOCD to use different .cfg files, users can choose whether to download via Jlink or GDLink.

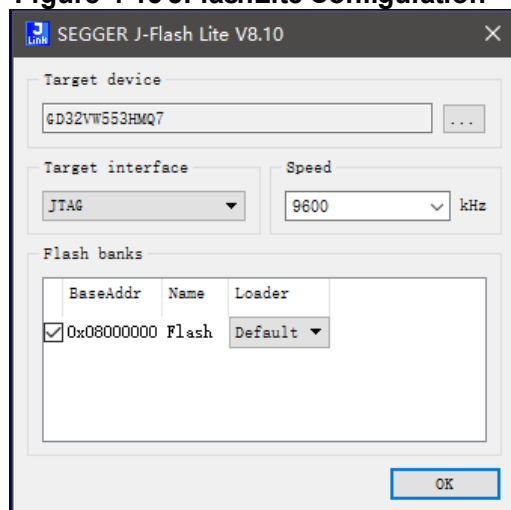
When using GDLink to connect the computer and development board, set LINKCFG to openocd\_gdlink.cfg. For connections via Jlink, set LINKCFG to openocd\_jlink.cfg.

After compilation, Afterbuild will invoke this script to execute the configured commands and complete the corresponding image download (please uncomment the lines within the red box from the figure; this feature is disabled by default).

### 4.3.3. Using J-Flash Lite for downloading

When using Jlink for debugging and firmware downloading, you can find JFlashLite.exe in the directory: GD32EmbeddedBuilder\_v1.4.14.29824\Tools\J-Link. Double-click to open JFlashLite and configure it as shown in [Figure 4-15 JFlashLite Configuration](#).

**Figure 4-15 JFlashLite Configuration**



Set the Target device to GD32VW553xxxx, choose the Target interface as JTAG (cJTAG can also be selected, but it is slower), and set the Speed to 9600 kHz. Then click OK.

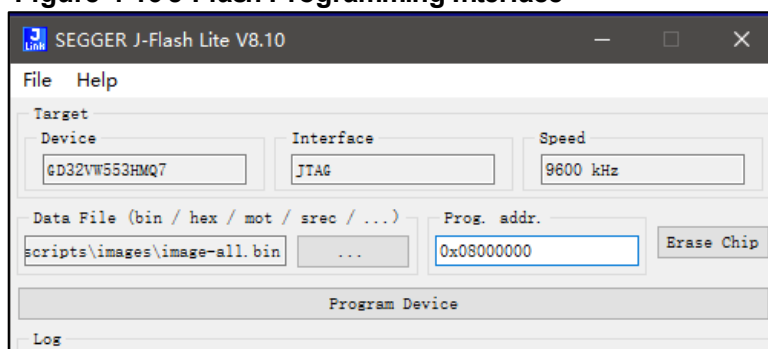
In the opened interface, as shown in [Figure 4-16 J-Flash Programming Interface](#), select the Data File as the compiled image-all.bin or image-ota.bin (stored in the directory GD32VW55x\_RELEASE\_V1.0.xx\scripts\images after compilation).

When selecting image-all.bin, set the Prog. Addr. on the right to 0x08000000.

When selecting image-ota.bin, set the Prog. Addr. on the right to 0x0800A000.

Once the settings are complete, click "Program Device" and wait for the progress bar to finish, which indicates the completion of the programming process.

**Figure 4-16 J-Flash Programming Interface**





## 4.4. Debugging

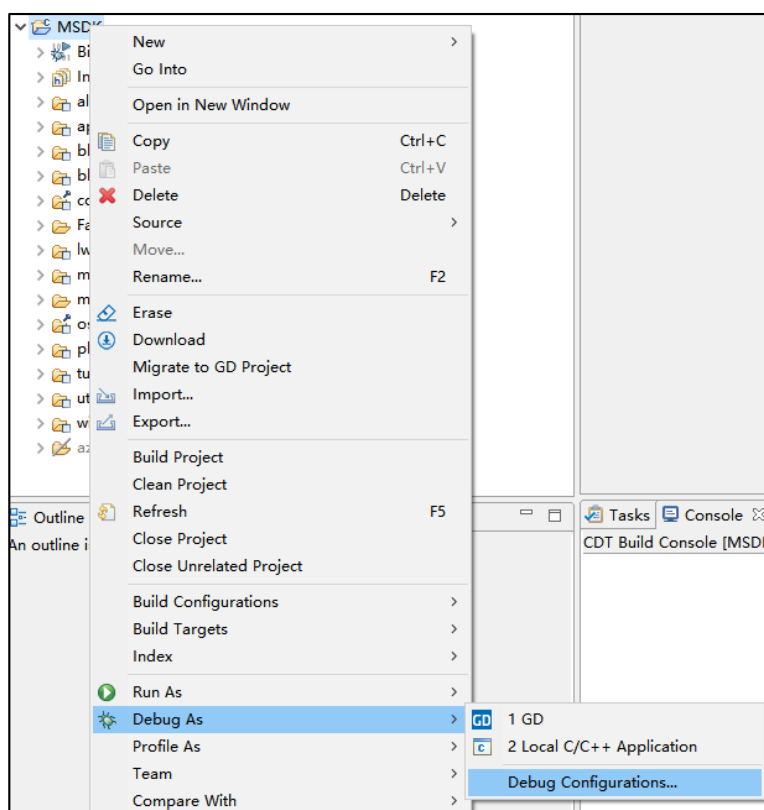
Currently, both the START development board and the EVAL development board feature onboard GDLink, and an external Jlink can also be used for debugging.

The debugging process is described below, and the default project configuration is msdk. If you need to switch to another project configuration, please refer to section [6.3Select different project configurations during debugging](#) for selecting different project configurations for debugging.

### 4.4.1. Debugging configuration

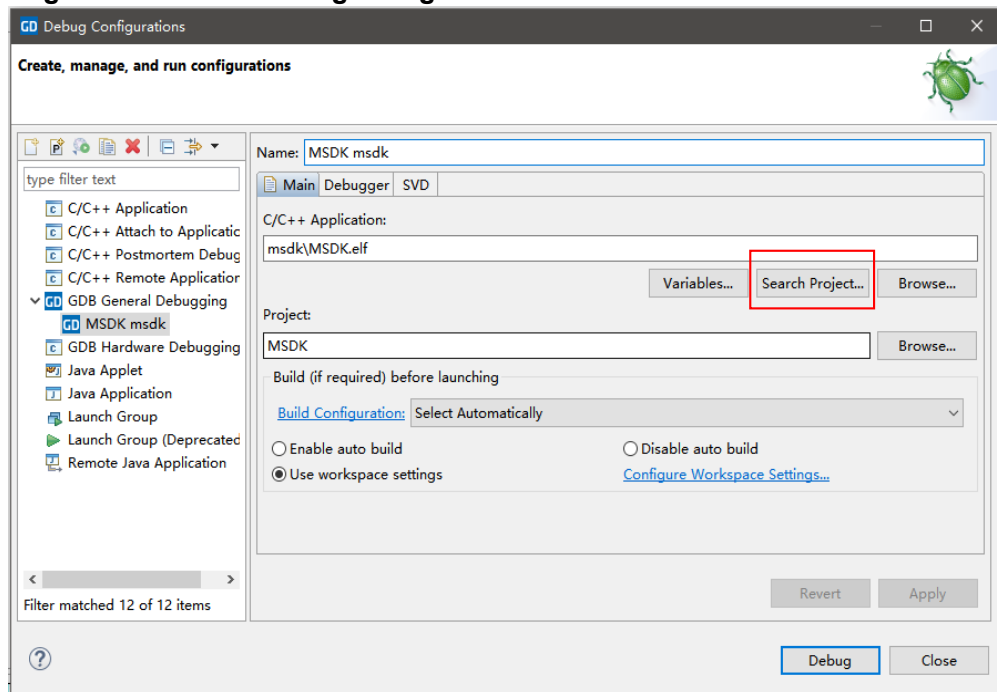
Right-click on the MSDK project and click Debug As->Debug Configurations, as shown in [Figure 4-17. Opening the Debug Configuration option.](#)

Figure 4-17. Opening the Debug Configuration option



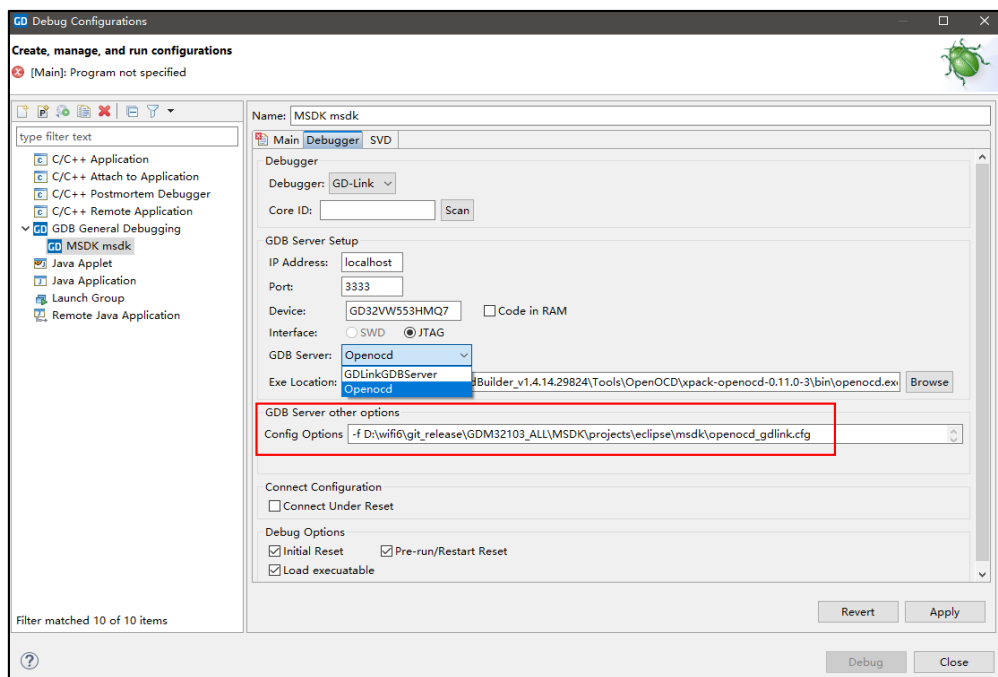
Double-click "GDB General Debugging" on the left, and a Debug configuration will automatically be created, as shown in [Figure 4-18. MSDK debug configuration](#). Here, the c/c++ application field has automatically selected msdk\MSDK.elf, which points to the ELF file generated by the configuration to be debugged.

You can check or uncheck "Enable/Disable auto build" to choose whether or not to compile the project before debugging.

**Figure 4-18. MSDK debug configuration**


#### 4.4.2. Debugging using GDLink

As shown in [Figure 4-19. MSDK Debugging Configuration Interface with openocd](#), switch the GDB Server to OpenOCD in the Debugger interface. Additionally, specify the Config Options within the red box as shown in the figure. Afterward, click "Debug" to start debugging. The debugging interface is displayed in [Figure 4-20. MSDK debug interface](#).

**Figure 4-19. MSDK Debugging Configuration Interface with openocd**


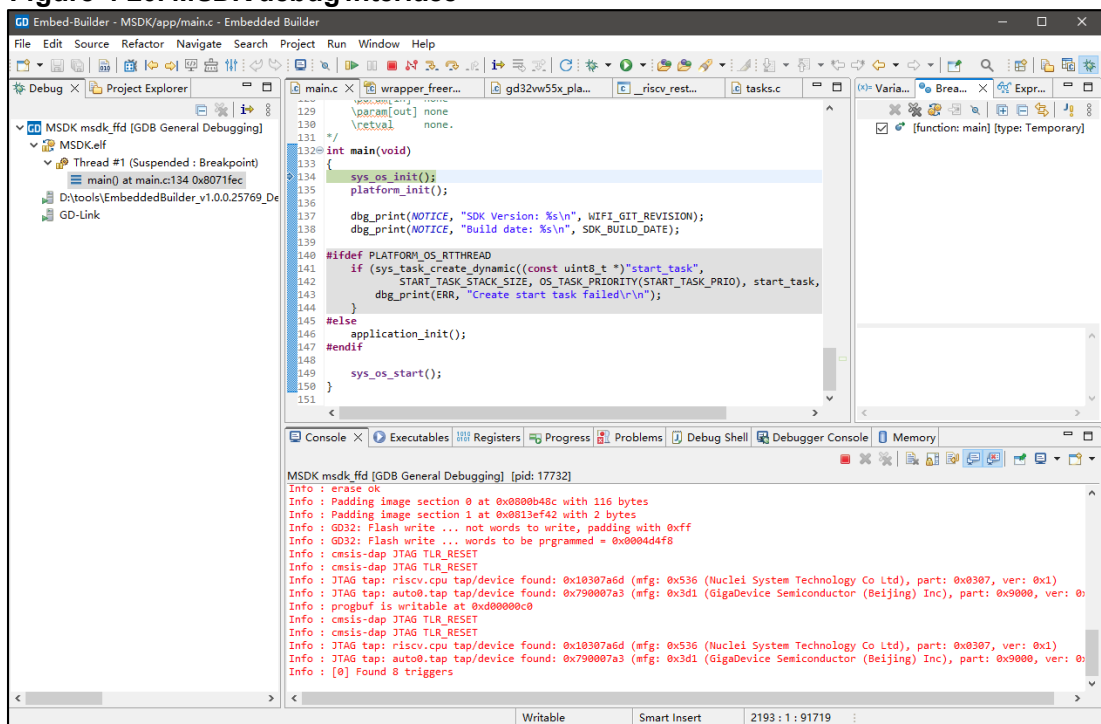
In [Figure 4-19. MSDK Debugging Configuration Interface with openocd](#), selecting "Initial

Reset" and "Pre-run/Restart Reset" in the Debug Options will reset the chip at the start of debugging. Choosing "Load executable" will flash the firmware once before debugging begins.

### 4.4.3. Debugging using Jlink

The GD32VW553 supports JTAG and cJTAG debugging. First, connect the pins of the JLink debugger to the GD32VW553 JTAG pins. Next, replace the cfg file within the red box in the [Figure 4-19. MSDK Debugging Configuration Interface with openocd](#) with "openocd\_jlink.cfg" (this file is located in the directory: MSDK\projects\ eclipse\msdk). Then, click "Debug" to enter the debugging process. If driver issues arise during JLink debugging, please refer to [6.4 JLink Driver Replacement](#).

**Figure 4-20. MSDK debug interface**



## 5. SEGGER Embedded Studio IDE project

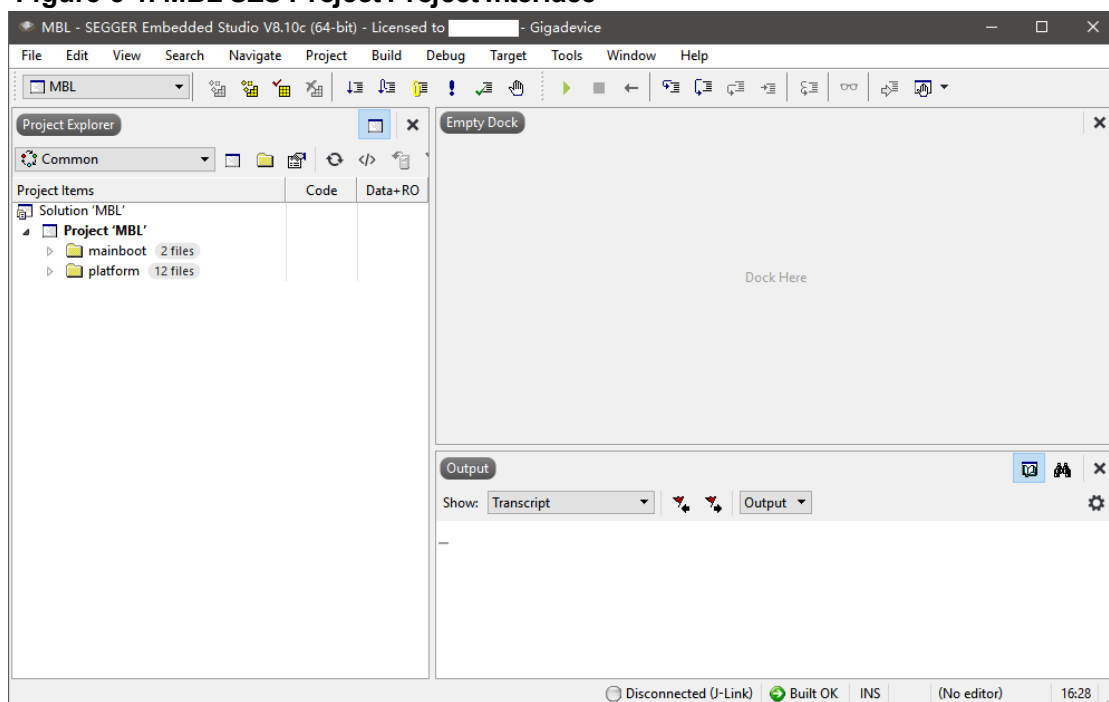
This chapter introduces how to compile and debug the SDK under SEGGER Embedded Studio IDE.

### 5.1. Open projects

#### ■ Open MBL project

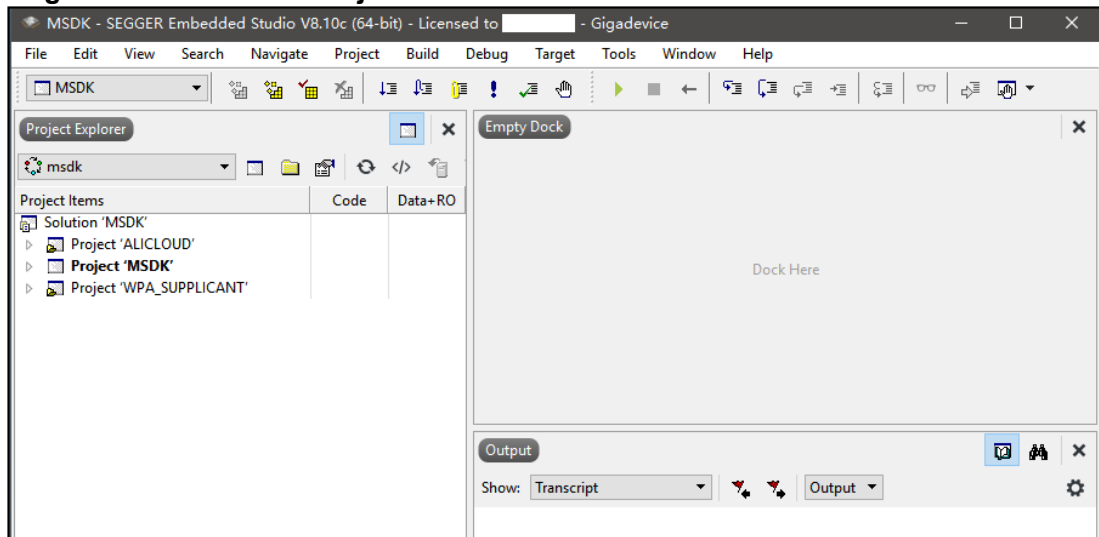
Open the directory: GD32VW55x\_RELEASE\MBL\project\segger, double click MBL.emProject to open the MBL SES project. The opened project is shown in [Figure 5-1. MBL SES Project Project Interface](#).

**Figure 5-1. MBL SES Project Project Interface**



#### ■ Open MSDK project

Open the directory: GD32VW55x\_RELEASE\MSDK\projects\segger, double-click on the MSDK.emProject to open the MSDK project, open the project as [Figure 5-2. MSDK SES Project Interface](#) shown.

**Figure 5-2. MSDK SES Project Interface**


## 5.2. Compilation

### ■ SES build tool configuration

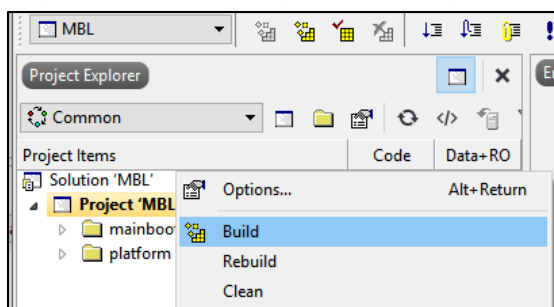
SES compiles the GD32VW55x project using the riscv32-none-elf toolchain by default. In order to better support the extended instruction set of riscv, it needs to be compiled using the nuclei toolchain: riscv-nuclei-elf. The compilation tool can be obtained by contacting sales or FAE. The details of the toolchain are shown in [Figure 5-3. nuclei toolchain content](#). Where the Segger\_IDE is the SES IDE installation directory.

**Figure 5-3. nuclei toolchain content**

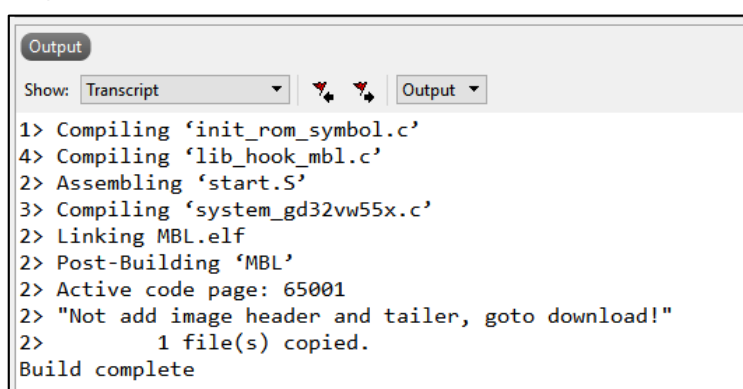
Segger_IDE > gcc > riscv-nuclei-elf		
名称	修改日期	类型
bin	2024/3/18 17:59	文件夹
include	2024/3/19 9:40	文件夹
lib	2024/7/12 15:21	文件夹

### ■ Compile the MBL project

Right-click the project and click build to build MBL, as shown in [Figure 5-4. Compiling the MBL project](#); or click Build->Build MBL in the menu bar.

**Figure 5-4. Compiling the MBL project**

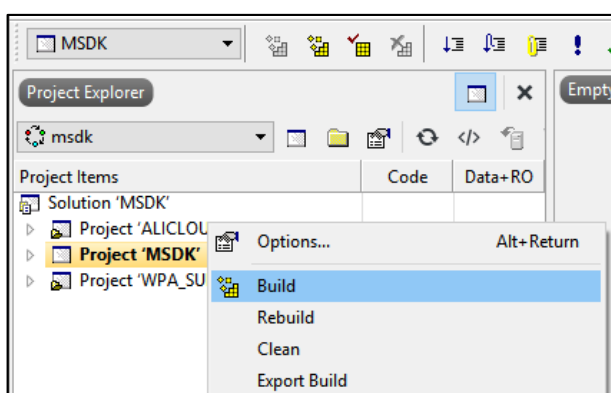
The compilation result is as shown in [Figure 5-5. MBL compilation result](#).

**Figure 5-5. MBL compilation result**

After the compilation is complete, the script MBL\project\mbl\_afterbuild.bat will be automatically called to generate mbl.bin and copied to the directory \scripts\images.

- Compile the MSDK project

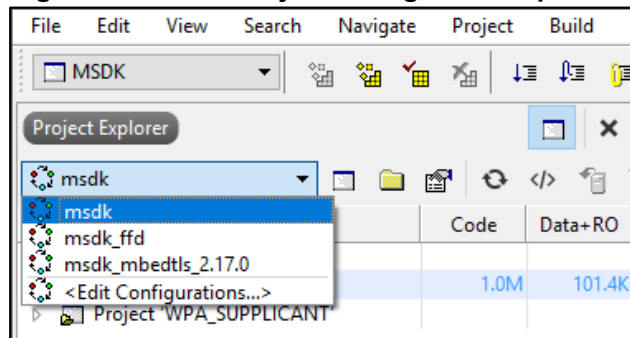
Right-click Project 'MSDK' and click Build, as shown in [Figure 5-6. Compile MSDK project](#)

**Figure 5-6. Compile MSDK project**

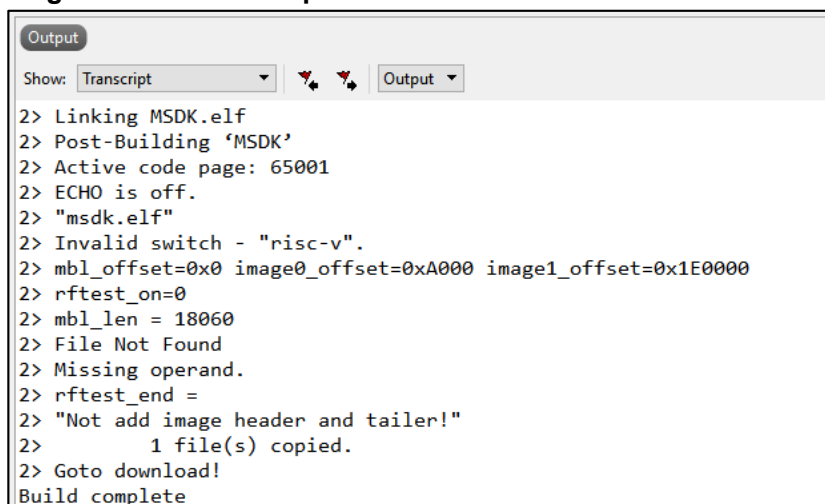
- Configuration selection of MSDK

MSDK configuration switch as shown in [Figure 5-7 MSDK Project Configuration Options](#).

MSDK SES project only supports msdk, msdk\_ffd and msdk\_mbedtls\_2.17.0; if you need to use the configuration of msdk\_threadx, msdk\_ffd\_threadx please use the GD32 EmbeddedBuilder IDE project or wait for subsequent updates.

**Figure 5-7 MSDK Project Configuration Options**

After selecting the corresponding configuration, right-click the project and click Build, the compilation result is shown in [Figure 5-8 MSDK compilation result](#).

**Figure 5-8 MSDK compilation result**

#### ■ Image generated by SDK

After MSDK is compiled, it will call MSDK\projects\image\_afterbuild.bat to generate image-ota.bin and image-all.bin, and copy the generated bin files to \scripts\images, as shown in [Figure 5-9. Images output](#).

image-ota.bin is the bin file generated by MSDK project, which can be used for OTA upgrade. image-all.bin is the combination of MBL(mbl.bin) and MSDK(image-ota.bin), the firmware can be used for production, download into flash and run.

**Figure 5-9. Images output**

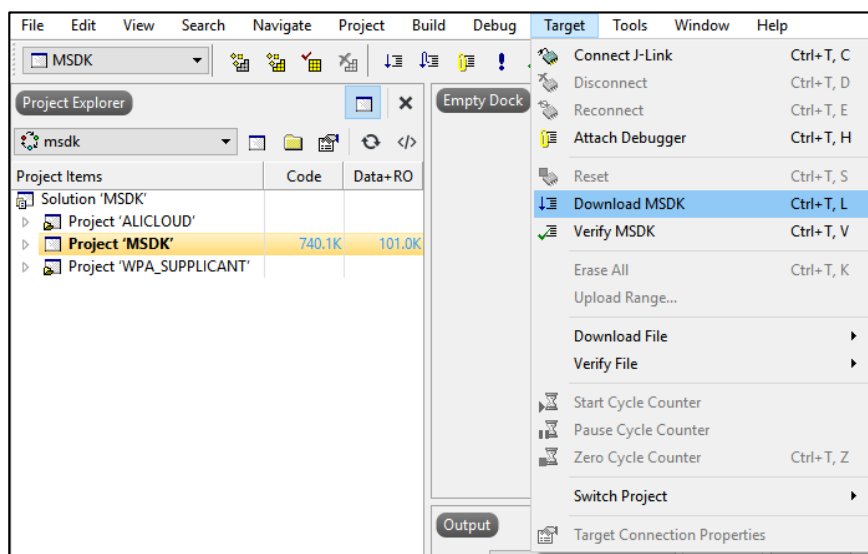
名称	修改日期	类型	大小
image-all.bin	2024/7/11 14:26	BIN 文件	788 KB
image-ota.bin	2024/7/11 14:26	BIN 文件	748 KB
mbl.bin	2024/7/11 14:19	BIN 文件	17 KB

## 5.3. Download firmware

Refer to [1.4 Download interface](#), copy GD32VW55x\_RELEASE\scripts\images\image-

all.bin to the GigaDevice disc to download it. Or download it by clicking Target->Download MSDK in the menu bar, as shown in [Figure 5-10 SES IDE image download](#).

**Figure 5-10 SES IDE image download**



## 5.4. Debugging

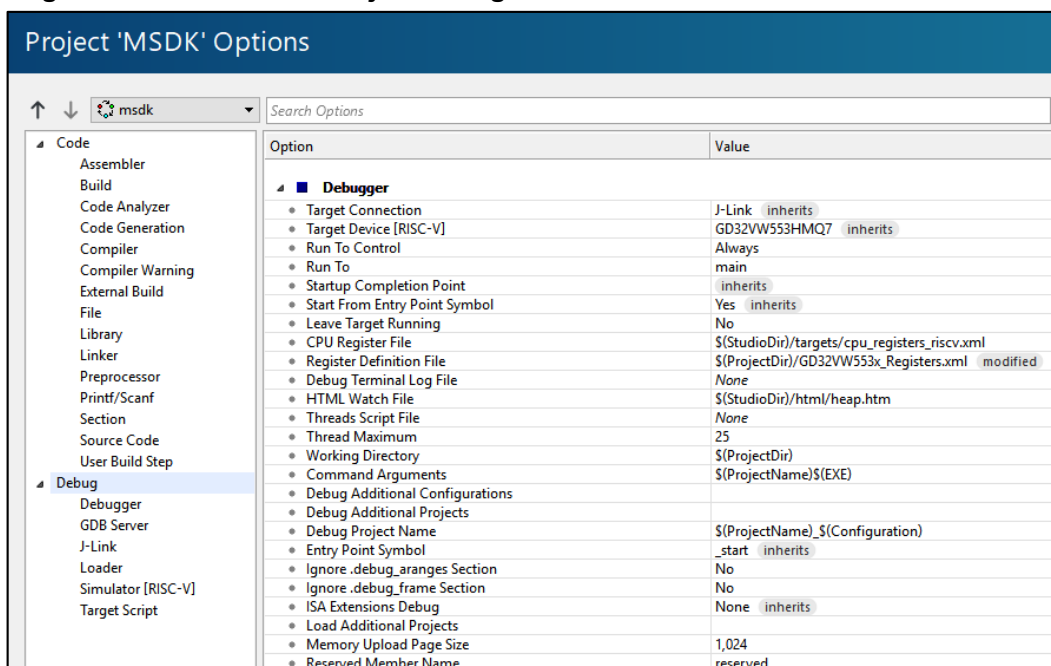
### ■ Debugging configuration

SES IDE recommends using J-link to debug, and J-link driver version at least V7.92o, this version of J-link driver support GD32VW55x chip.

The project has been configured with Debug information by default, if you need to change it, right-click on the MSDK project, click Options to open the configuration interface, you can modify the Debugger and JLink under the Debug option, as shown in [Figure 5-11. MSDK SES Project Configuration Interface](#).



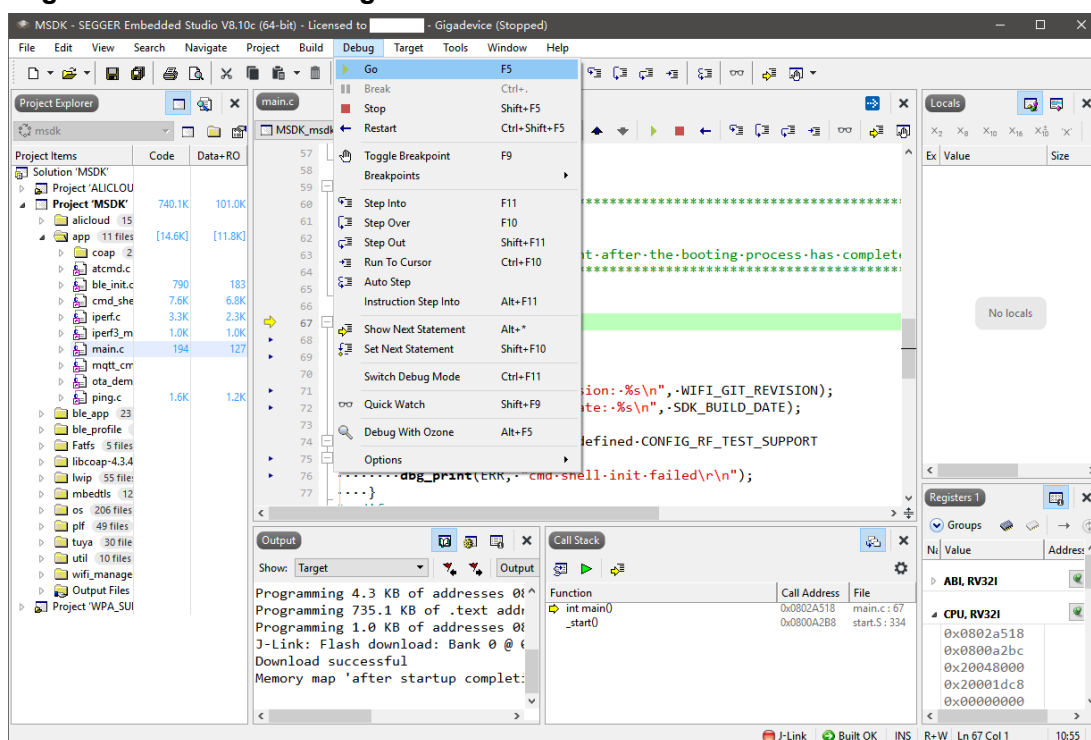
**Figure 5-11. MSDK SES Project Configuration Interface**



### ■ Start Debugging

Click Debug->GO in the menu bar to debug, click and wait for the image downloading to complete and enter the interface shown in [Figure 5-12. SES IDE Debug Interface](#).

**Figure 5-12. SES IDE Debug Interface**



## 6. FAQ

### 6.1. No image error

Print ERR: No image to boot (ret = -5).

**Reason:** An error occurs during the previous boot of WIFI\_IOT, and the MBL records operation exception of the IMAGE. If another IMAGE is not downloaded or also has a boot exception, this message will be printed. In other words, the MBL believes that there is no valid IMAGE to jump to, and the boot fails.

**Solution:** Download the MBL again. After that, the IMAGE status will be cleared.

### 6.2. Code running in SRAM

To run programs faster to achieve higher performance, move them to the SRAM.

Open GD32VW55x\_RELEASE\MSDK\p\frisc\env\gd32w55x.ld, and find the line ".code\_to\_sram:". The code in the braces runs in the SRAM. To add new content, add it at the end of the code. Refer to existing files for the format, for example:

```
KEEP ( *port.o* (.text* .rodata*))
```

It is to put the entire port.c file in the SRAM and run it. For example:

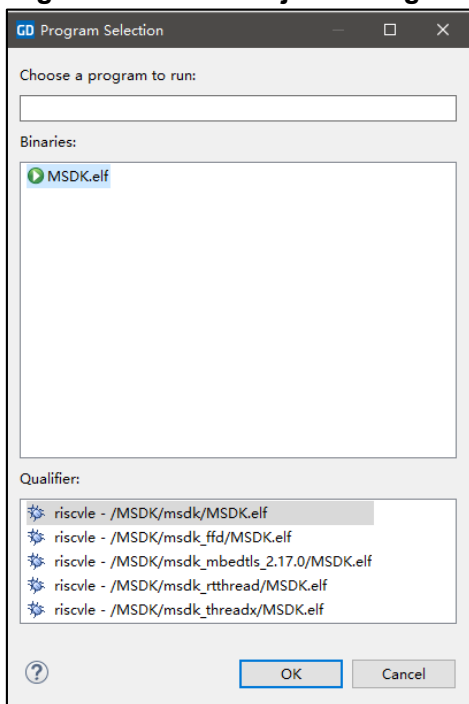
```
KEEP (*tasks.o* (.text.xTaskIncrementTick))
```

It is to put the xTaskIncrementTick () function in tasks.c in the SRAM and run it.

### 6.3. Select different project configurations during debugging

The MSDK project supports multiple configurations (refer to [3.2.6 Configuration Selection](#)). During debugging, you need to select the appropriate configuration.

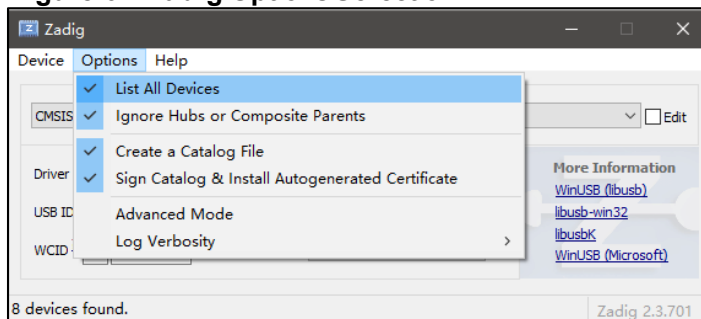
The specific operation is as follows: Click the "Search Project" button within the red box shown in [Figure 4-18. MSDK debug configuration](#). This opens the interface shown in [Figure 6-1 Select Project Configuration for Debugging](#). Double-click the configuration you want to debug within the Qualifier box below (note that you need to compile the corresponding configuration first for the option to appear).

**Figure 6-1 Select Project Configuration for Debugging**


## 6.4. JLink Driver Replacement

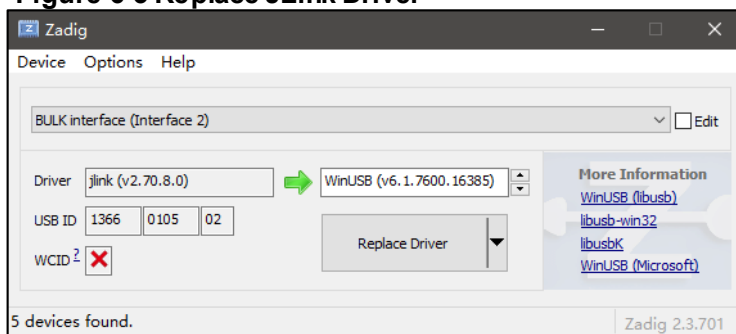
When using OpenOCD+JLink debugging in an Embedded Builder project, if encountering the issue "Error: No J-Link device found," JLink drivers need to be replaced. The steps are as follows:

1. Use administrator privileges to open the zadig.exe file (official website: <https://zadig.akeo.ie>). Click "Options" and check "List All Devices," as shown in [Figure 6-2 Zadig Options Selection](#).

**Figure 6-2 Zadig Options Selection**


2. Select "JLink devices" from the dropdown menu, as shown in [Figure 6-3 Replace JLink Driver](#), where the BULK interface is displayed. Click "Replace Driver" to replace the JLink driver with WinUSB.

**Figure 6-3 Replace JLink Driver**



3. After the replacement is complete, unplug and replug the JLink device. Then use JLink for debugging, and there will be no driver issues.

## 7. Revision history

**Table 7-1. Revision history**

Revision No.	Description	Date
1.0	Initial release	Nov.24.2023
1.1	Chapter 2 revision	Jan.26.2024
1.2	SES IDE project added, GD32 Eclipse IDE updated to GD32 Embedded Builder	July.17. 2024
1.3	Update some diagrams to be consistent with SDK1.0.3	Apr.8.2025
1.3a	Update the development board images and add firmw are dow nloads	May.15.2025

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